

## Final datasheet

### EasyPACK™ module with CoolSiC™ Trench MOSFET and PressFIT / NTC

#### Features

- Electrical features
  - $V_{DS} = 2000\text{ V}$
  - $I_{DN} = 160\text{ A}$  /  $I_{DRM} = 320\text{ A}$
  - Overload operation up to  $175^{\circ}\text{C}$
  - Suitable Infineon gate drivers can be found under <https://www.infineon.com/gdfinder>
- Mechanical features
  - Integrated NTC temperature sensor
  - PressFIT contact technology



#### Potential applications

- EV charging
- Energy storage systems (ESS)
- Solar applications
- DC/DC converter

#### Product validation

- Qualified for industrial applications according to the relevant tests of IEC 60747, 60749 and 60068

#### Description

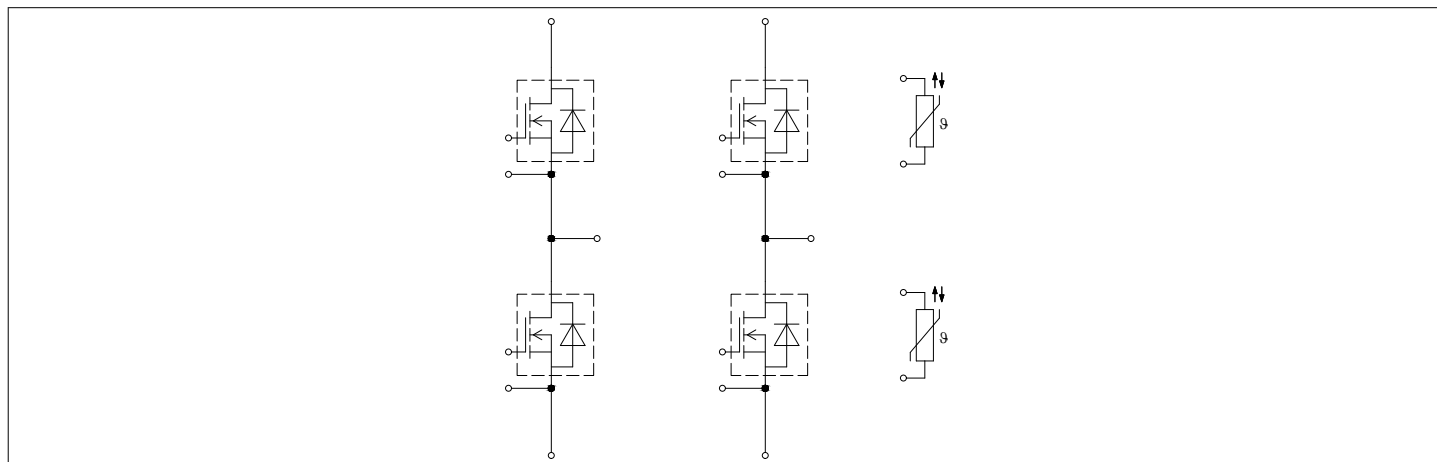




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## 1 Package

**Table 1** Insulation coordination

| Parameter                           | Symbol          | Note or test condition                         | Values    | Unit |
|-------------------------------------|-----------------|------------------------------------------------|-----------|------|
| Isolation test voltage              | $V_{ISOL}$      | RMS, $f = 50 \text{ Hz}$ , $t = 1 \text{ min}$ | 3.2       | kV   |
| Isolation test voltage NTC          | $V_{ISOL(NTC)}$ | RMS, $f = 50 \text{ Hz}$ , $t = 1 \text{ min}$ | 3.2       | kV   |
| Internal isolation                  |                 | basic insulation (class 1, IEC 61140)          | $Al_2O_3$ |      |
| Comparative tracking index          | $CTI$           |                                                | > 400     |      |
| Relative thermal index (electrical) | $RTI$           | housing                                        | 140       | °C   |

**Table 2** Characteristic values

| Parameter                                | Symbol        | Note or test condition                         | Values    |      |      | Unit |
|------------------------------------------|---------------|------------------------------------------------|-----------|------|------|------|
|                                          |               |                                                | Min.      | Typ. | Max. |      |
| Stray inductance module                  | $L_{SCE}$     |                                                |           | 22   |      | nH   |
| Module lead resistance, terminals - chip | $R_{CC'+EE'}$ | $T_H = 25 \text{ °C}$ , per switch             |           | 1.4  |      | mΩ   |
| Storage temperature                      | $T_{stg}$     |                                                | -40       |      | 125  | °C   |
| Mounting torque for module mounting      | $M$           | - Mounting according to valid application note | M5, Screw | 1.3  | 1.5  | Nm   |
| Weight                                   | $G$           |                                                |           | 78   |      | g    |

**Note:** The current under continuous operation is limited to 25A rms per connector pin.

## 2 MOSFET, T1-T4

**Table 3** Maximum rated values

| Parameter                                   | Symbol    | Note or test condition                              |                          | Values | Unit |
|---------------------------------------------|-----------|-----------------------------------------------------|--------------------------|--------|------|
| Drain-source voltage                        | $V_{DSS}$ |                                                     | $T_{vj} = 25 \text{ °C}$ | 2000   | V    |
| Implemented drain current                   | $I_{DN}$  |                                                     |                          | 160    | A    |
| Continuous DC drain current                 | $I_{DDC}$ | $T_{vj} = 175 \text{ °C}$ , $V_{GS} = 18 \text{ V}$ | $T_H = 65 \text{ °C}$    | 135    | A    |
| Repetitive peak drain current               | $I_{DRM}$ | verified by design, $t_p$ limited by $T_{vjmax}$    |                          | 320    | A    |
| Gate-source voltage, max. transient voltage | $V_{GS}$  | $D < 0.01$                                          |                          | -10/23 | V    |
| Gate-source voltage, max. static voltage    | $V_{GS}$  |                                                     |                          | -7/20  | V    |

**Table 4 Recommended values**

| Parameter              | Symbol        | Note or test condition | Values  | Unit |
|------------------------|---------------|------------------------|---------|------|
| On-state gate voltage  | $V_{GS(on)}$  |                        | 15...18 | V    |
| Off-state gate voltage | $V_{GS(off)}$ |                        | -5...-2 | V    |

**Table 5 Characteristic values**

| Parameter                           | Symbol       | Note or test condition                                                                                                                                                 |                                                | Values |       |      | Unit |
|-------------------------------------|--------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------------------------------------------------|--------|-------|------|------|
|                                     |              |                                                                                                                                                                        |                                                | Min.   | Typ.  | Max. |      |
| Drain-source on-resistance          | $R_{DS(on)}$ | $I_D = 160\text{ A}$                                                                                                                                                   | $V_{GS} = 18\text{ V}, T_{vj} = 25\text{ °C}$  |        | 5.1   | 8.1  | mΩ   |
|                                     |              |                                                                                                                                                                        | $V_{GS} = 18\text{ V}, T_{vj} = 125\text{ °C}$ |        | 10.9  |      |      |
|                                     |              |                                                                                                                                                                        | $V_{GS} = 18\text{ V}, T_{vj} = 175\text{ °C}$ |        | 15.4  |      |      |
|                                     |              |                                                                                                                                                                        | $V_{GS} = 15\text{ V}, T_{vj} = 25\text{ °C}$  |        | 5.6   |      |      |
| Gate threshold voltage              | $V_{GS(th)}$ | $I_D = 112\text{ mA}, V_{DS} = V_{GS}, (\text{tested after 1ms pulse at } V_{GS} = +20\text{ V}), T_{vj} = 25\text{ °C}$                                               |                                                | 3.45   | 4.3   | 5.15 | V    |
| Total gate charge                   | $Q_G$        | $V_{DD} = 1200\text{ V}, V_{GS} = -3\text{ V}, T_{vj} = 25\text{ °C}$                                                                                                  |                                                |        | 0.78  |      | μC   |
| Internal gate resistor              | $R_{Gint}$   | $T_{vj} = 25\text{ °C}$                                                                                                                                                |                                                |        | 1.8   |      | Ω    |
| Input capacitance                   | $C_{ISS}$    | $f = 100\text{ kHz}, V_{DS} = 1200\text{ V}, V_{GS} = 0\text{ V}$                                                                                                      | $T_{vj} = 25\text{ °C}$                        |        | 24.1  |      | nF   |
| Output capacitance                  | $C_{OSS}$    | $f = 100\text{ kHz}, V_{DS} = 1200\text{ V}, V_{GS} = 0\text{ V}$                                                                                                      | $T_{vj} = 25\text{ °C}$                        |        | 0.563 |      | nF   |
| Reverse transfer capacitance        | $C_{rSS}$    | $f = 100\text{ kHz}, V_{DS} = 1200\text{ V}, V_{GS} = 0\text{ V}$                                                                                                      | $T_{vj} = 25\text{ °C}$                        |        | 0.041 |      | nF   |
| $C_{OSS}$ stored energy             | $E_{OSS}$    | $V_{DS} = 1200\text{ V}, V_{GS} = -3/18\text{ V}, T_{vj} = 25\text{ °C}$                                                                                               |                                                |        | 508   |      | μJ   |
| Drain-source leakage current        | $I_{DSS}$    | $V_{DS} = 2000\text{ V}, V_{GS} = -3\text{ V}$                                                                                                                         | $T_{vj} = 25\text{ °C}$                        |        | 0.04  | 378  | μA   |
| Gate-source leakage current         | $I_{GSS}$    | $V_{DS} = 0\text{ V}, T_{vj} = 25\text{ °C}$                                                                                                                           | $V_{GS} = 20\text{ V}$                         |        |       | 400  | nA   |
| Turn-on delay time (inductive load) | $t_{d on}$   | $I_D = 160\text{ A}, R_{Gon} = 4.3\text{ Ω}, V_{DD} = 1200\text{ V}, V_{GS} = -3/18\text{ V}, t_{dead} = 1000\text{ ns}, 0.1\text{ }V_{GS} \text{ to } 0.1\text{ }I_D$ | $T_{vj} = 25\text{ °C}$                        |        | 70    |      | ns   |
|                                     |              |                                                                                                                                                                        | $T_{vj} = 125\text{ °C}$                       |        | 69    |      |      |
|                                     |              |                                                                                                                                                                        | $T_{vj} = 175\text{ °C}$                       |        | 69    |      |      |
| Rise time (inductive load)          | $t_r$        | $I_D = 160\text{ A}, R_{Gon} = 4.3\text{ Ω}, V_{DD} = 1200\text{ V}, V_{GS} = -3/18\text{ V}, t_{dead} = 1000\text{ ns}, 0.1\text{ }I_D \text{ to } 0.9\text{ }I_D$    | $T_{vj} = 25\text{ °C}$                        |        | 29    |      | ns   |
|                                     |              |                                                                                                                                                                        | $T_{vj} = 125\text{ °C}$                       |        | 29    |      |      |
|                                     |              |                                                                                                                                                                        | $T_{vj} = 175\text{ °C}$                       |        | 29    |      |      |

(table continues...)

**Table 5** (continued) Characteristic values

| Parameter                                 | Symbol       | Note or test condition                                                                                                                                                                                                                     | Values                   |       |      | Unit |
|-------------------------------------------|--------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--------------------------|-------|------|------|
|                                           |              |                                                                                                                                                                                                                                            | Min.                     | Typ.  | Max. |      |
| Turn-off delay time<br>(inductive load)   | $t_{d\ off}$ | $I_D = 160\text{ A}$ , $R_{Goff} = 0.51\ \Omega$ ,<br>$V_{DD} = 1200\text{ V}$ ,<br>$V_{GS} = -3/18\text{ V}$ , $0.9\ V_{GS}$ to<br>$0.9\ I_D$                                                                                             | $T_{vj} = 25\text{ °C}$  | 107   |      | ns   |
|                                           |              |                                                                                                                                                                                                                                            | $T_{vj} = 125\text{ °C}$ | 113   |      |      |
|                                           |              |                                                                                                                                                                                                                                            | $T_{vj} = 175\text{ °C}$ | 119   |      |      |
| Fall time (inductive load)                | $t_f$        | $I_D = 160\text{ A}$ , $R_{Goff} = 0.51\ \Omega$ ,<br>$V_{DD} = 1200\text{ V}$ ,<br>$V_{GS} = -3/18\text{ V}$ , $0.9\ I_D$ to $0.1\ I_D$                                                                                                   | $T_{vj} = 25\text{ °C}$  | 33    |      | ns   |
|                                           |              |                                                                                                                                                                                                                                            | $T_{vj} = 125\text{ °C}$ | 36    |      |      |
|                                           |              |                                                                                                                                                                                                                                            | $T_{vj} = 175\text{ °C}$ | 38    |      |      |
| Turn-on energy loss per pulse             | $E_{on}$     | $I_D = 160\text{ A}$ , $V_{DD} = 1200\text{ V}$ ,<br>$L_\sigma = 15\text{ nH}$ , $V_{GS} = -3/18\text{ V}$ ,<br>$R_{Gon} = 4.3\ \Omega$ , $di/dt = 4.5\text{ kA}/\mu\text{s}$ ( $T_{vj} = 175\text{ °C}$ ),<br>$t_{dead} = 1000\text{ ns}$ | $T_{vj} = 25\text{ °C}$  | 10.8  |      | mJ   |
|                                           |              |                                                                                                                                                                                                                                            | $T_{vj} = 125\text{ °C}$ | 12.5  |      |      |
|                                           |              |                                                                                                                                                                                                                                            | $T_{vj} = 175\text{ °C}$ | 15.1  |      |      |
| Turn-on energy loss per pulse, optimized  | $E_{on,o}$   | $I_D = 160\text{ A}$ , $V_{DD} = 1200\text{ V}$ ,<br>$L_\sigma = 15\text{ nH}$ , $V_{GS} = -3/18\text{ V}$ ,<br>$R_{Gon,o} = 2.4\ \Omega$ , $di/dt = 6\text{ kA}/\mu\text{s}$ ( $T_{vj} = 175\text{ °C}$ ),<br>$t_{dead} = 100\text{ ns}$  | $T_{vj} = 25\text{ °C}$  | 7.6   |      | mJ   |
|                                           |              |                                                                                                                                                                                                                                            | $T_{vj} = 125\text{ °C}$ | 7.9   |      |      |
|                                           |              |                                                                                                                                                                                                                                            | $T_{vj} = 175\text{ °C}$ | 8.7   |      |      |
| Turn-off energy loss per pulse            | $E_{off}$    | $I_D = 160\text{ A}$ , $V_{DD} = 1200\text{ V}$ ,<br>$L_\sigma = 15\text{ nH}$ , $V_{GS} = -3/18\text{ V}$ ,<br>$R_{Goff} = 0.51\ \Omega$ , $dv/dt = 38.5\text{ kV}/\mu\text{s}$ ( $T_{vj} = 175\text{ °C}$ )                              | $T_{vj} = 25\text{ °C}$  | 2.7   |      | mJ   |
|                                           |              |                                                                                                                                                                                                                                            | $T_{vj} = 125\text{ °C}$ | 3     |      |      |
|                                           |              |                                                                                                                                                                                                                                            | $T_{vj} = 175\text{ °C}$ | 3.1   |      |      |
| Thermal resistance, junction to heat sink | $R_{thJH}$   | per MOSFET, $\lambda_{grease} = 3.3\text{ W}/(\text{m}\cdot\text{K})$                                                                                                                                                                      |                          | 0.238 |      | K/W  |
| Temperature under switching conditions    | $T_{vj\ op}$ |                                                                                                                                                                                                                                            | -40                      |       | 175  | °C   |

**Note:** The selection of positive and negative gate-source voltages impacts losses and the long-term behavior of the MOSFET and body diode. The design guidelines described in Application Notes AN 2018-09 and AN 2021-13 must be considered to ensure sound operation of the device over the planned lifetime.

$T_{vj\ op} > 150\text{ °C}$  is allowed for operation at overload conditions. For detailed specifications, please refer to AN 2018-14.

### 3 Body diode (MOSFET, T1-T4)

**Table 6** Maximum rated values

| Parameter                     | Symbol   | Note or test condition                                                 | Values | Unit |
|-------------------------------|----------|------------------------------------------------------------------------|--------|------|
| DC body diode forward current | $I_{SD}$ | $T_{vj} = 175\text{ °C}$ , $V_{GS} = -3\text{ V}$ $T_H = 65\text{ °C}$ | 100    | A    |

**Table 7** Characteristic values

| Parameter                          | Symbol      | Note or test condition                                                                                                                                                              | Values                    |      |      | Unit          |
|------------------------------------|-------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---------------------------|------|------|---------------|
|                                    |             |                                                                                                                                                                                     | Min.                      | Typ. | Max. |               |
| Forward voltage                    | $V_{SD}$    | $I_{SD} = 160 \text{ A}$ , $V_{GS} = -3 \text{ V}$                                                                                                                                  | $T_{vj} = 25 \text{ °C}$  | 4.4  | 5.95 | V             |
|                                    |             |                                                                                                                                                                                     | $T_{vj} = 125 \text{ °C}$ | 4    |      |               |
|                                    |             |                                                                                                                                                                                     | $T_{vj} = 175 \text{ °C}$ | 3.85 |      |               |
| Peak reverse recovery current      | $I_{rrm}$   | $I_{SD} = 160 \text{ A}$ , $di_s/dt = 4.5 \text{ kA}/\mu\text{s}$ , $V_{DD} = 1200 \text{ V}$ , $V_{GS} = -3 \text{ V}$ , $t_{dead} = 1000 \text{ ns}$                              | $T_{vj} = 25 \text{ °C}$  | 88   |      | A             |
|                                    |             |                                                                                                                                                                                     | $T_{vj} = 125 \text{ °C}$ | 118  |      |               |
|                                    |             |                                                                                                                                                                                     | $T_{vj} = 175 \text{ °C}$ | 162  |      |               |
| Recovered charge                   | $Q_{rr}$    | $I_{SD} = 160 \text{ A}$ , $di_s/dt = 4.5 \text{ kA}/\mu\text{s}$ , $V_{DD} = 1200 \text{ V}$ , $V_{GS} = -3 \text{ V}$ , $t_{dead} = 1000 \text{ ns}$                              | $T_{vj} = 25 \text{ °C}$  | 4.3  |      | $\mu\text{C}$ |
|                                    |             |                                                                                                                                                                                     | $T_{vj} = 125 \text{ °C}$ | 5.9  |      |               |
|                                    |             |                                                                                                                                                                                     | $T_{vj} = 175 \text{ °C}$ | 8.8  |      |               |
| Reverse recovery energy            | $E_{rec}$   | $I_{SD} = 160 \text{ A}$ , $di_s/dt = 4.5 \text{ kA}/\mu\text{s}$ ( $T_{vj} = 175 \text{ °C}$ ), $V_{DD} = 1200 \text{ V}$ , $V_{GS} = -3 \text{ V}$ , $t_{dead} = 1000 \text{ ns}$ | $T_{vj} = 25 \text{ °C}$  | 3.5  |      | mJ            |
|                                    |             |                                                                                                                                                                                     | $T_{vj} = 125 \text{ °C}$ | 4.3  |      |               |
|                                    |             |                                                                                                                                                                                     | $T_{vj} = 175 \text{ °C}$ | 5.4  |      |               |
| Reverse recovery energy, optimized | $E_{rec,o}$ | $I_{SD} = 160 \text{ A}$ , $di_s/dt = 6 \text{ kA}/\mu\text{s}$ ( $T_{vj} = 175 \text{ °C}$ ), $V_{DD} = 1200 \text{ V}$ , $V_{GS} = -3 \text{ V}$ , $t_{dead} = 100 \text{ ns}$    | $T_{vj} = 25 \text{ °C}$  | 2.5  |      | mJ            |
|                                    |             |                                                                                                                                                                                     | $T_{vj} = 125 \text{ °C}$ | 2.8  |      |               |
|                                    |             |                                                                                                                                                                                     | $T_{vj} = 175 \text{ °C}$ | 4.1  |      |               |

## 4 NTC-Thermistor

**Table 8** Characteristic values

| Parameter              | Symbol       | Note or test condition                                        | Values |      |      | Unit       |
|------------------------|--------------|---------------------------------------------------------------|--------|------|------|------------|
|                        |              |                                                               | Min.   | Typ. | Max. |            |
| Rated resistance       | $R_{25}$     | $T_{NTC} = 25 \text{ °C}$                                     |        | 5    |      | k $\Omega$ |
| Deviation of $R_{100}$ | $\Delta R/R$ | $T_{NTC} = 100 \text{ °C}$ , $R_{100} = 493 \text{ }\Omega$   | -5     |      | 5    | %          |
| Power dissipation      | $P_{25}$     | $T_{NTC} = 25 \text{ °C}$                                     |        |      | 20   | mW         |
| B-value                | $B_{25/50}$  | $R_2 = R_{25} \exp[B_{25/50}(1/T_2 - 1/(298,15 \text{ K}))]$  |        | 3375 |      | K          |
| B-value                | $B_{25/80}$  | $R_2 = R_{25} \exp[B_{25/80}(1/T_2 - 1/(298,15 \text{ K}))]$  |        | 3411 |      | K          |
| B-value                | $B_{25/100}$ | $R_2 = R_{25} \exp[B_{25/100}(1/T_2 - 1/(298,15 \text{ K}))]$ |        | 3433 |      | K          |

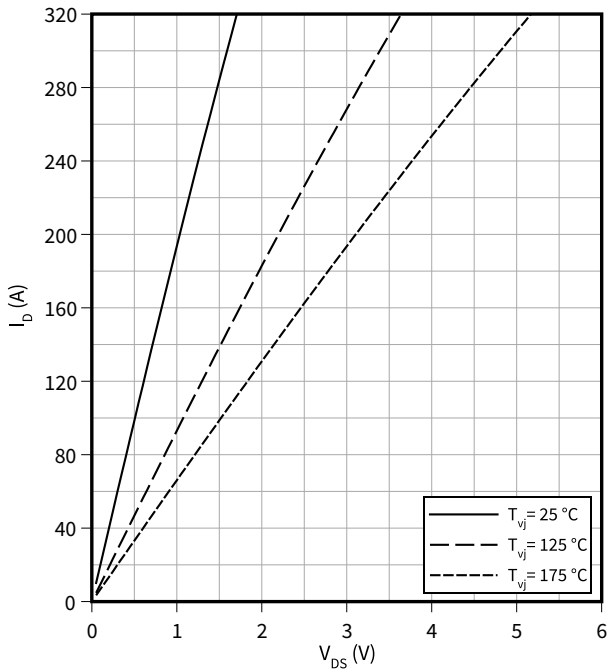
**Note:** For an analytical description of the NTC characteristics please refer to AN2009-10, chapter 4

5 Characteristics diagrams

Output characteristic (typical), MOSFET, T1-T4

$I_D = f(V_{DS})$

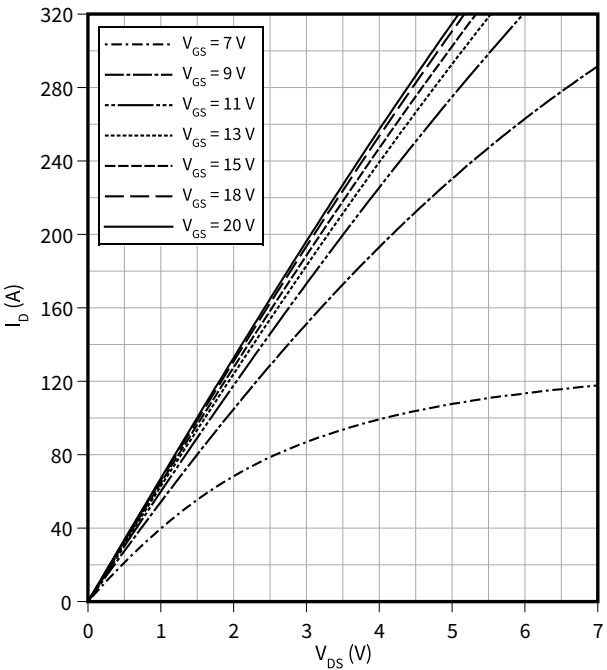
$V_{GS} = 18\text{ V}$



Output characteristic field (typical), MOSFET, T1-T4

$I_D = f(V_{DS})$

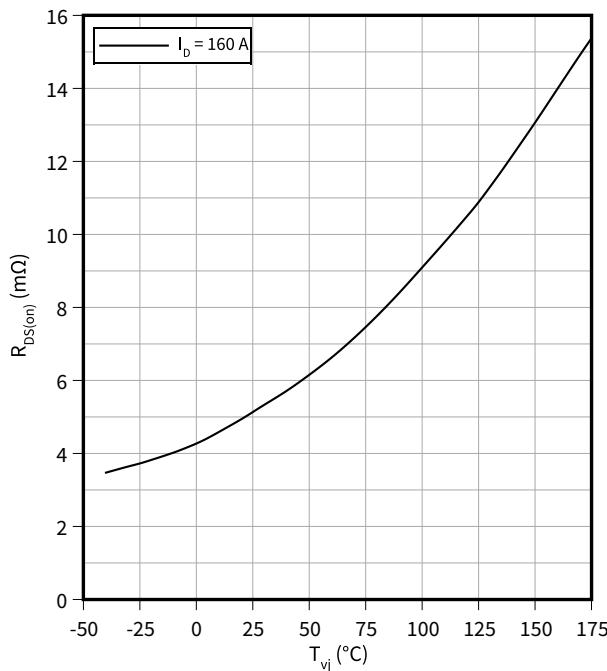
$T_{vj} = 175^\circ\text{C}$



Drain source on-resistance (typical), MOSFET, T1-T4

$R_{DS(on)} = f(T_{vj})$

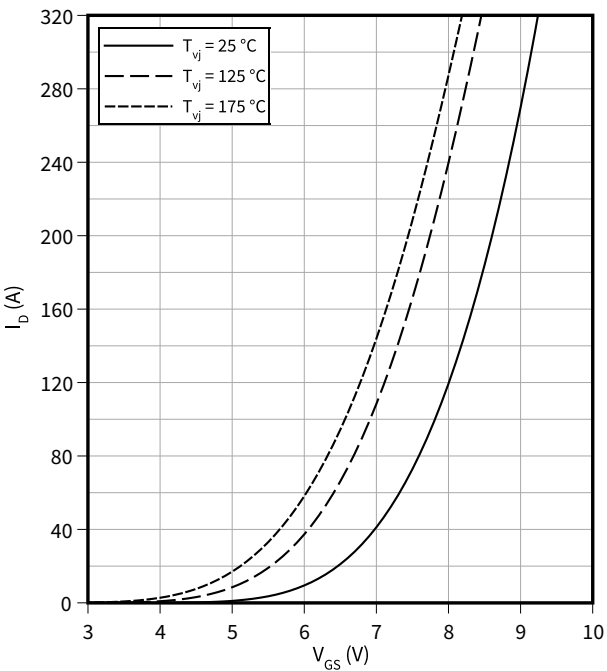
$V_{GS} = 18\text{ V}$



Transfer characteristic (typical), MOSFET, T1-T4

$I_D = f(V_{GS})$

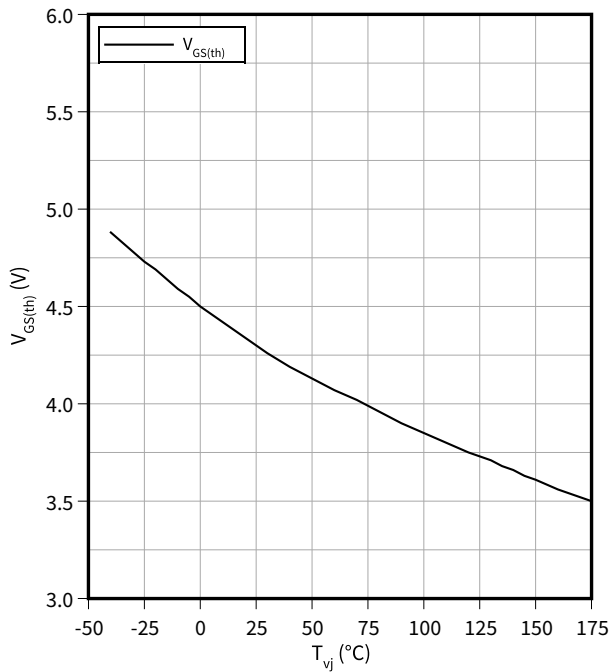
$V_{DS} = 20\text{ V}$



5 Characteristics diagrams

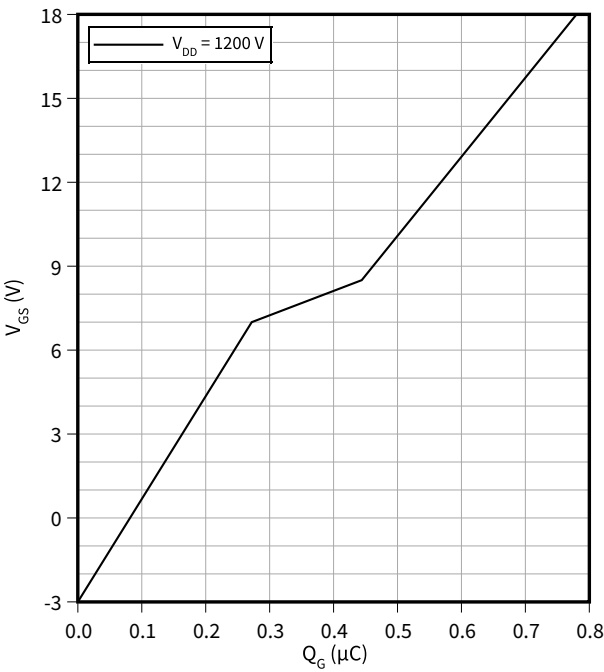
Gate-source threshold voltage (typical), MOSFET, T1-T4

$V_{GS(th)} = f(T_{vj})$   
 $I_D = 112 \text{ mA}, V_{GS} = V_{DS}$



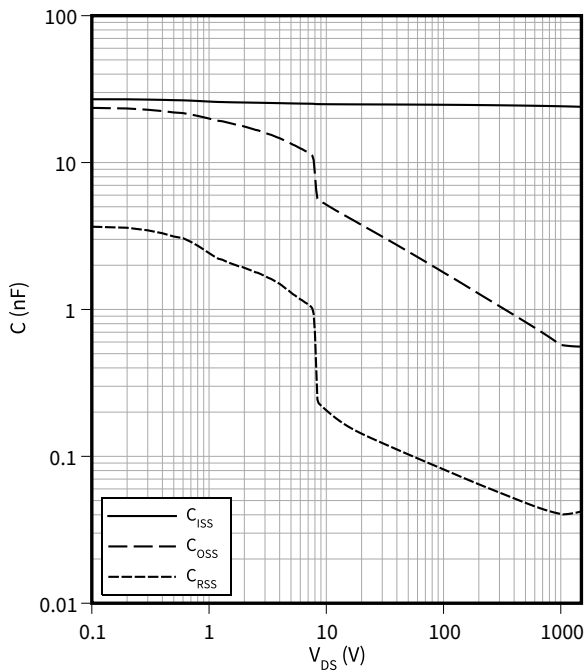
Gate charge characteristic (typical), MOSFET, T1-T4

$V_{GS} = f(Q_G)$   
 $I_D = 160 \text{ A}, T_{vj} = 25 \text{ °C}$



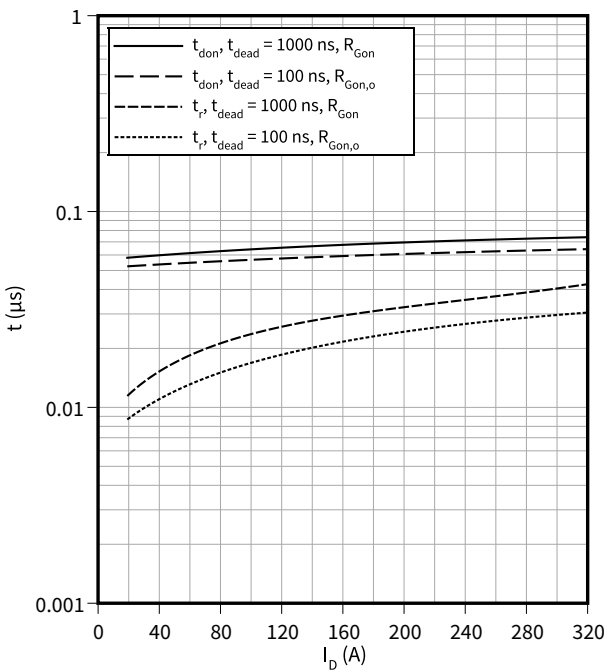
Capacity characteristic (typical), MOSFET, T1-T4

$C = f(V_{DS})$   
 $f = 100 \text{ kHz}, T_{vj} = 25 \text{ °C}, V_{GS} = 0 \text{ V}$



Switching times (typical), MOSFET, T1-T4

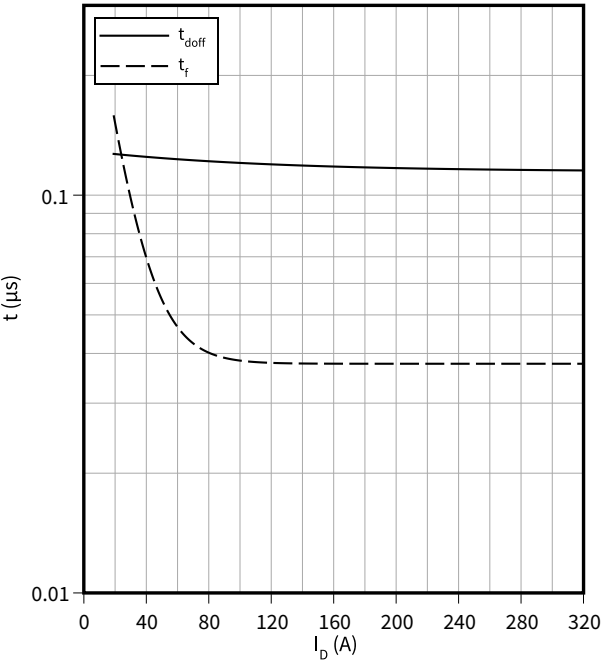
$t = f(I_D)$   
 $V_{DD} = 1200 \text{ V}, R_{Gon} = 4.3 \text{ } \Omega, R_{Gon,o} = 2.4 \text{ } \Omega, T_{vj} = 175 \text{ °C}, V_{GS} = -3/18 \text{ V}$



5 Characteristics diagrams

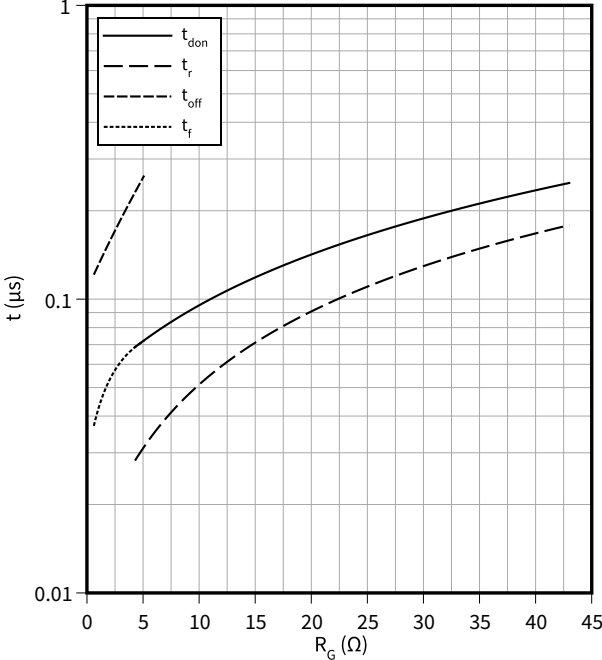
Switching times (typical), MOSFET, T1-T4

$t = f(I_D)$   
 $R_{Goff} = 0.51 \Omega$ ,  $V_{DD} = 1200 \text{ V}$ ,  $T_{vj} = 175 \text{ }^\circ\text{C}$ ,  $V_{GS} = -3/18 \text{ V}$



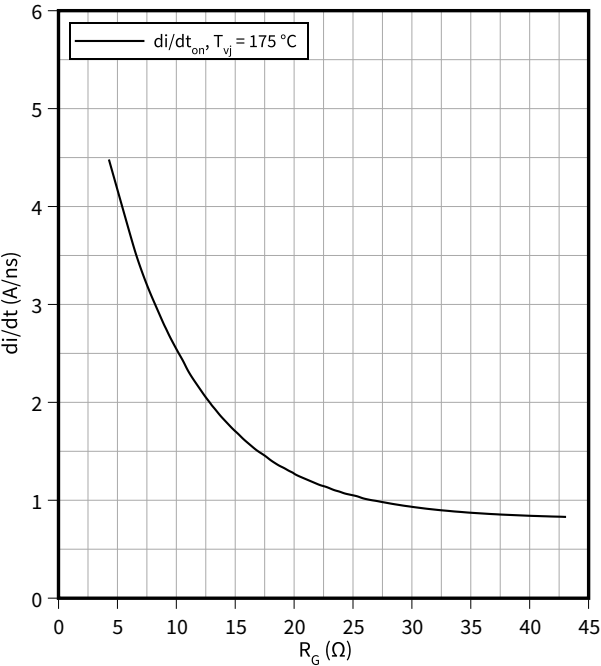
Switching times (typical), MOSFET, T1-T4

$t = f(R_G)$   
 $V_{DD} = 1200 \text{ V}$ ,  $t_{dead} = 1000 \text{ ns}$ ,  $I_D = 160 \text{ A}$ ,  $T_{vj} = 175 \text{ }^\circ\text{C}$ ,  $V_{GS} = -3/18 \text{ V}$



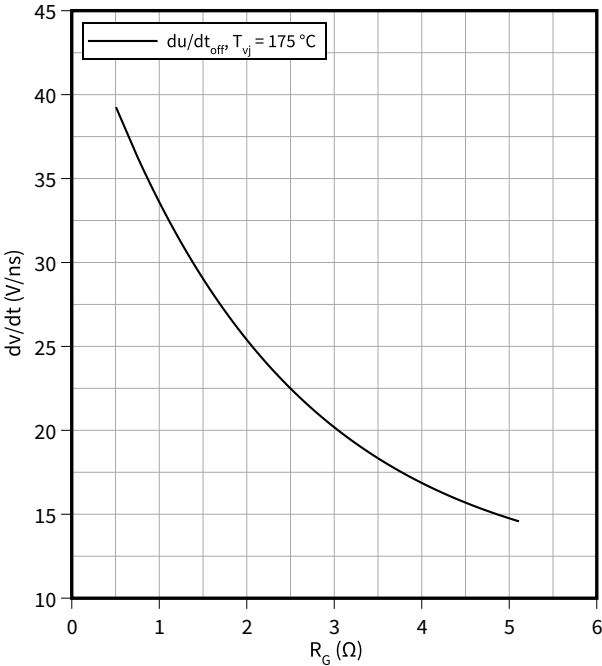
Current slope (typical), MOSFET, T1-T4

$di/dt = f(R_G)$   
 $V_{DD} = 1200 \text{ V}$ ,  $I_D = 160 \text{ A}$ ,  $V_{GS} = -3/18 \text{ V}$



Voltage slope (typical), MOSFET, T1-T4

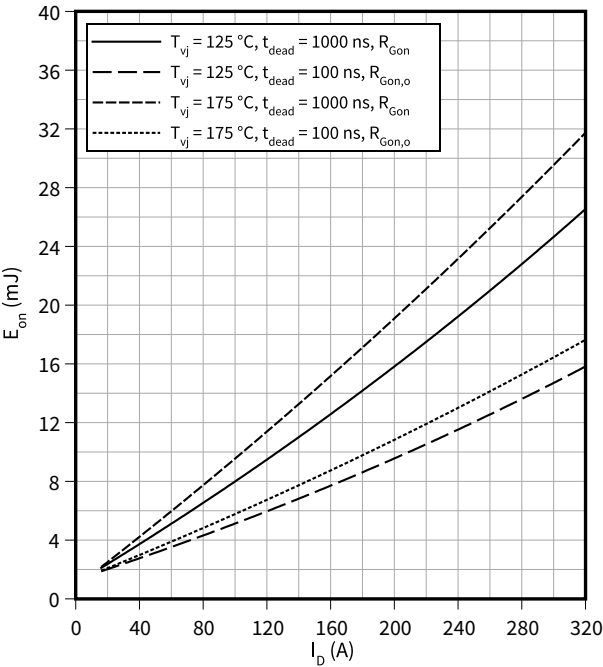
$dv/dt = f(R_G)$   
 $V_{DD} = 1200 \text{ V}$ ,  $I_D = 160 \text{ A}$ ,  $V_{GS} = -3/18 \text{ V}$



5 Characteristics diagrams

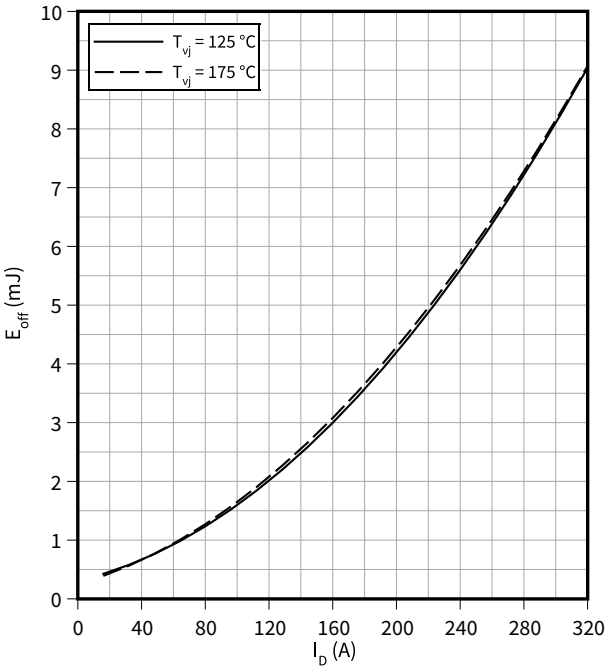
Switching losses (typical), MOSFET, T1-T4

$E_{on} = f(I_D)$   
 $V_{DD} = 1200\text{ V}$ ,  $R_{Gon} = 4.3\ \Omega$ ,  $R_{Gon,o} = 2.4\ \Omega$ ,  $V_{GS} = -3/18\text{ V}$



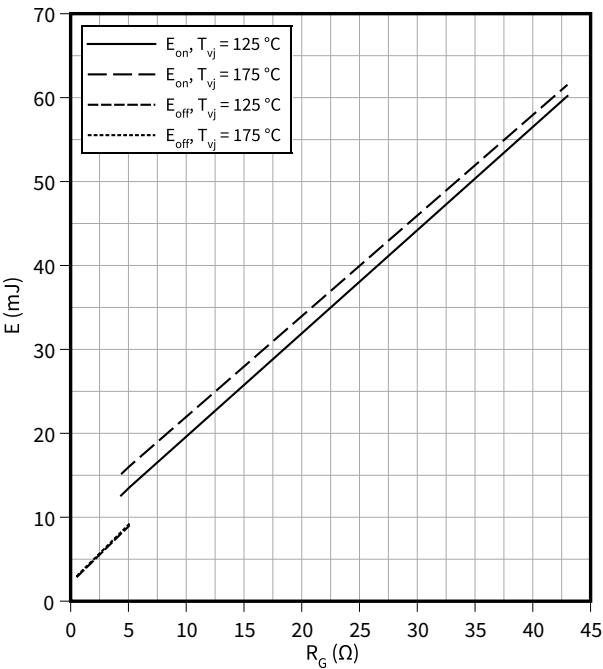
Switching losses (typical), MOSFET, T1-T4

$E_{off} = f(I_D)$   
 $R_{Goff} = 0.51\ \Omega$ ,  $V_{DD} = 1200\text{ V}$ ,  $V_{GS} = -3/18\text{ V}$



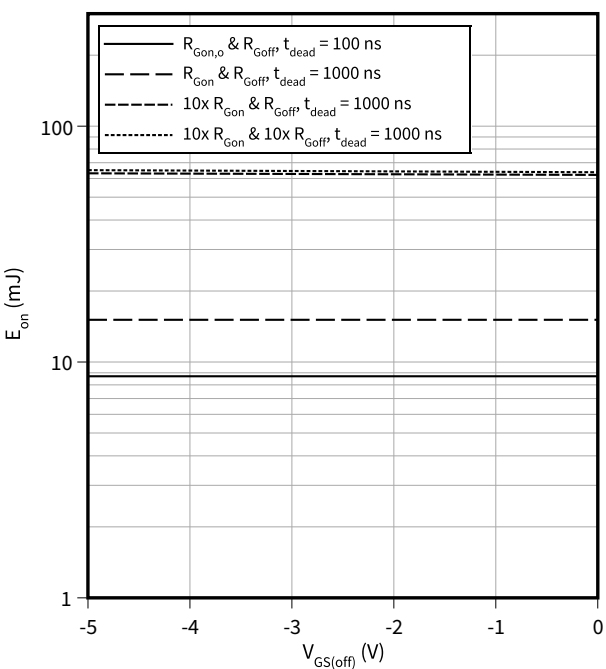
Switching losses (typical), MOSFET, T1-T4

$E = f(R_G)$   
 $V_{DD} = 1200\text{ V}$ ,  $t_{dead} = 1000\text{ ns}$ ,  $I_D = 160\text{ A}$ ,  $V_{GS} = -3/18\text{ V}$



Switching losses (typical), MOSFET, T1-T4

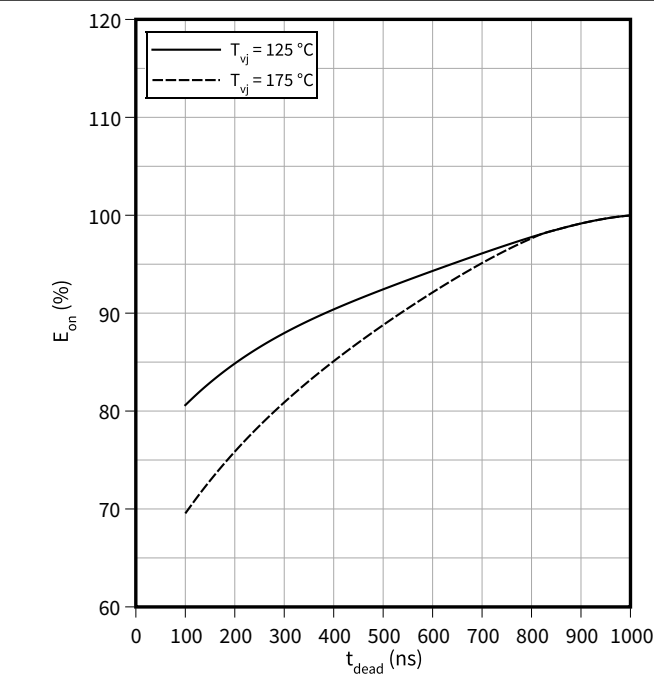
$E_{on} = f(V_{GS(off)})$   
 $R_{Goff} = 0.51\ \Omega$ ,  $V_{DD} = 1200\text{ V}$ ,  $R_{Gon} = 4.3\ \Omega$ ,  $V_{GS(on)} = 18\text{ V}$ ,  $I_D = 160\text{ A}$ ,  $R_{Gon,o} = 2.4\ \Omega$ ,  $T_{vj} = 175\text{ °C}$



5 Characteristics diagrams

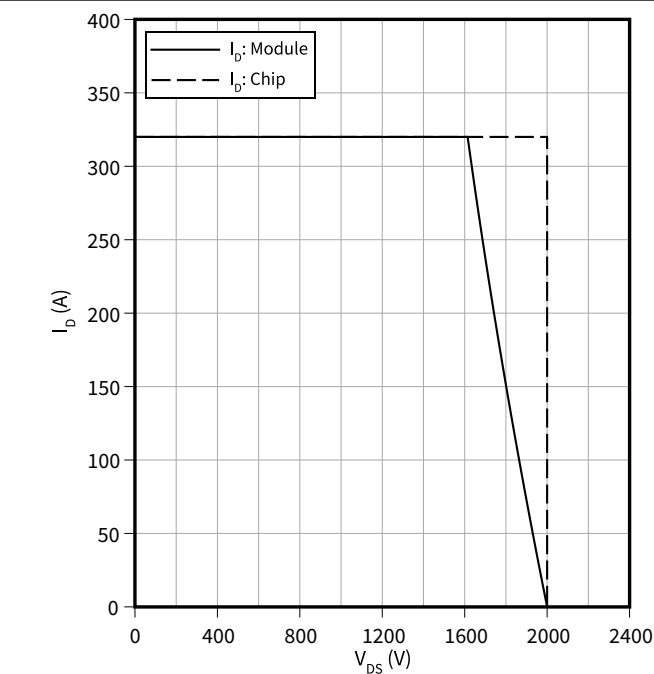
Switching losses (typical), MOSFET, T1-T4

$E_{on} = f(t_{dead})$   
 $R_{Gon} = 4.3\ \Omega$ ,  $I_D = 160\ A$ ,  $V_{DD} = 1200\ V$ ,  $V_{GS} = -3/18\ V$



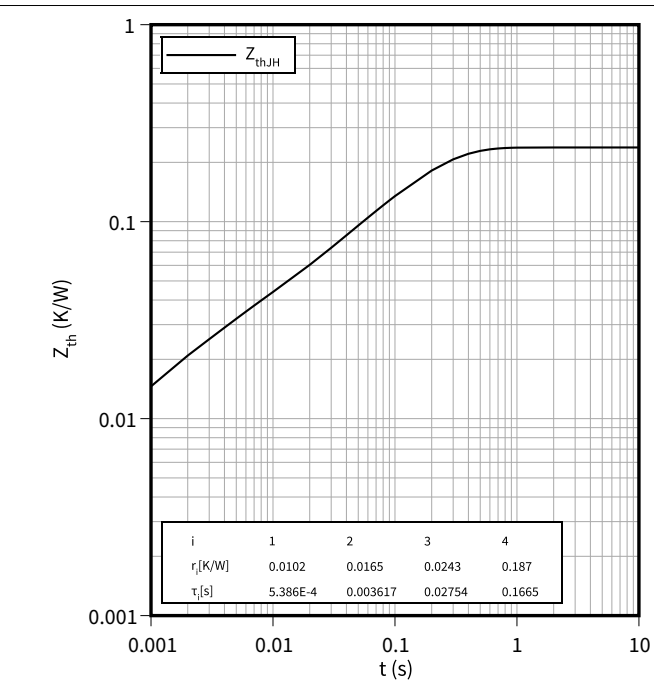
Reverse bias safe operating area (RBSOA), MOSFET, T1-T4

$I_D = f(V_{DS})$   
 $R_{Goff} = 0.51\ \Omega$ ,  $T_{vj} = 175\ ^\circ C$ ,  $V_{GS} = -3/18\ V$



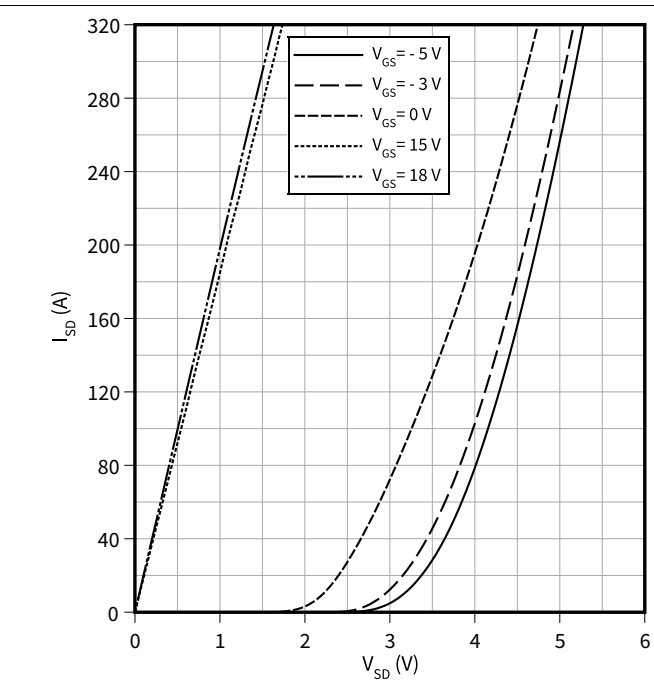
Transient thermal impedance, MOSFET, T1-T4

$Z_{th} = f(t)$



Forward characteristic body diode (typical), MOSFET, T1-T4

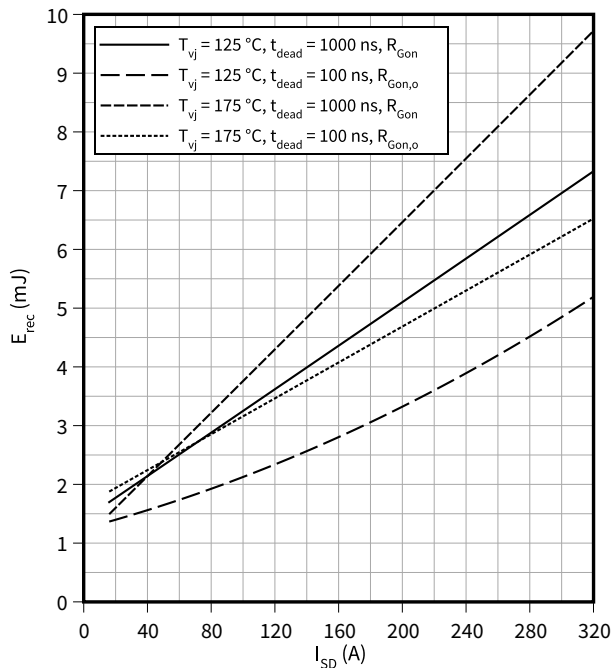
$I_{SD} = f(V_{SD})$   
 $T_{vj} = 25\ ^\circ C$



5 Characteristics diagrams

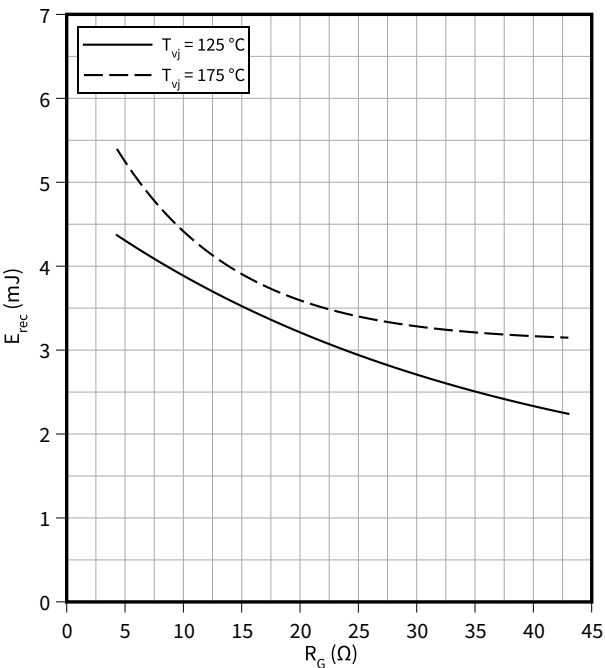
Switching losses body diode (typical), MOSFET, T1-T4

$E_{rec} = f(I_{SD})$   
 $R_{Gon} = 4.3 \Omega$ ,  $R_{Gon,o} = 2.4 \Omega$ ,  $V_{DD} = 1200 V$



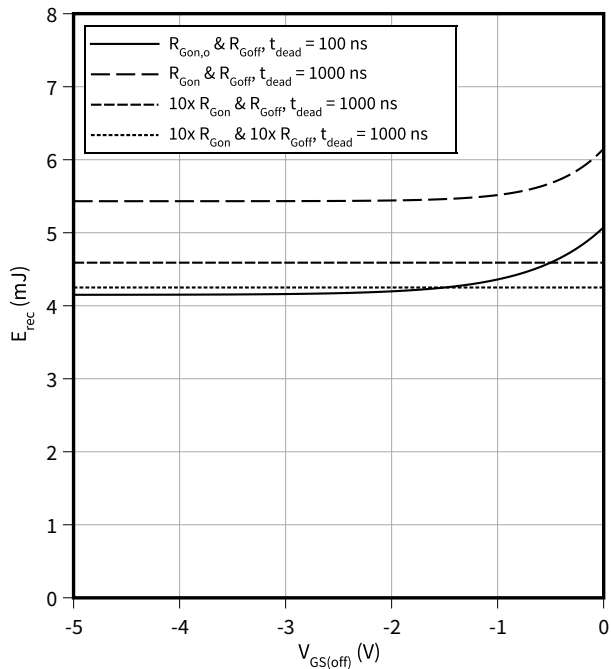
Switching losses body diode (typical), MOSFET, T1-T4

$E_{rec} = f(R_G)$   
 $t_{dead} = 1000 ns$ ,  $I_{SD} = 160 A$ ,  $V_{DD} = 1200 V$



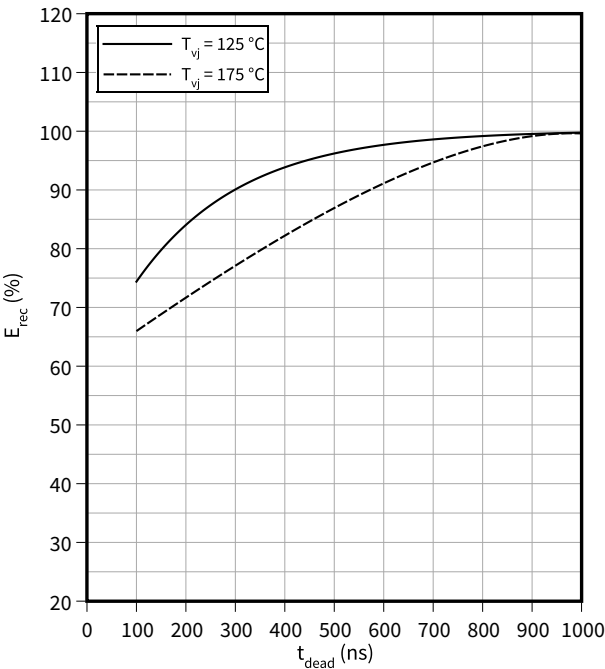
Switching losses body diode (typical), MOSFET, T1-T4

$E_{rec} = f(V_{GS(off)})$   
 $R_{Goff} = 0.51 \Omega$ ,  $R_{Gon} = 4.3 \Omega$ ,  $V_{GS(on)} = 18 V$ ,  $I_{SD} = 160 A$ ,  
 $R_{Gon,o} = 2.4 \Omega$ ,  $V_{DD} = 1200 V$ ,  $T_{vj} = 175 °C$



Switching losses body diode (typical), MOSFET, T1-T4

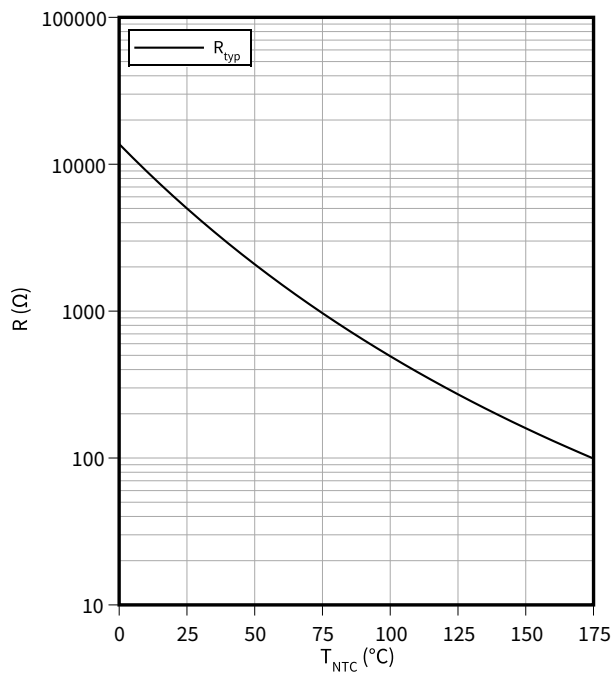
$E_{rec} = f(t_{dead})$   
 $R_{Gon} = 4.3 \Omega$ ,  $I_D = 160 A$ ,  $V_{DD} = 1200 V$ ,  $V_{GS} = -3/18 V$



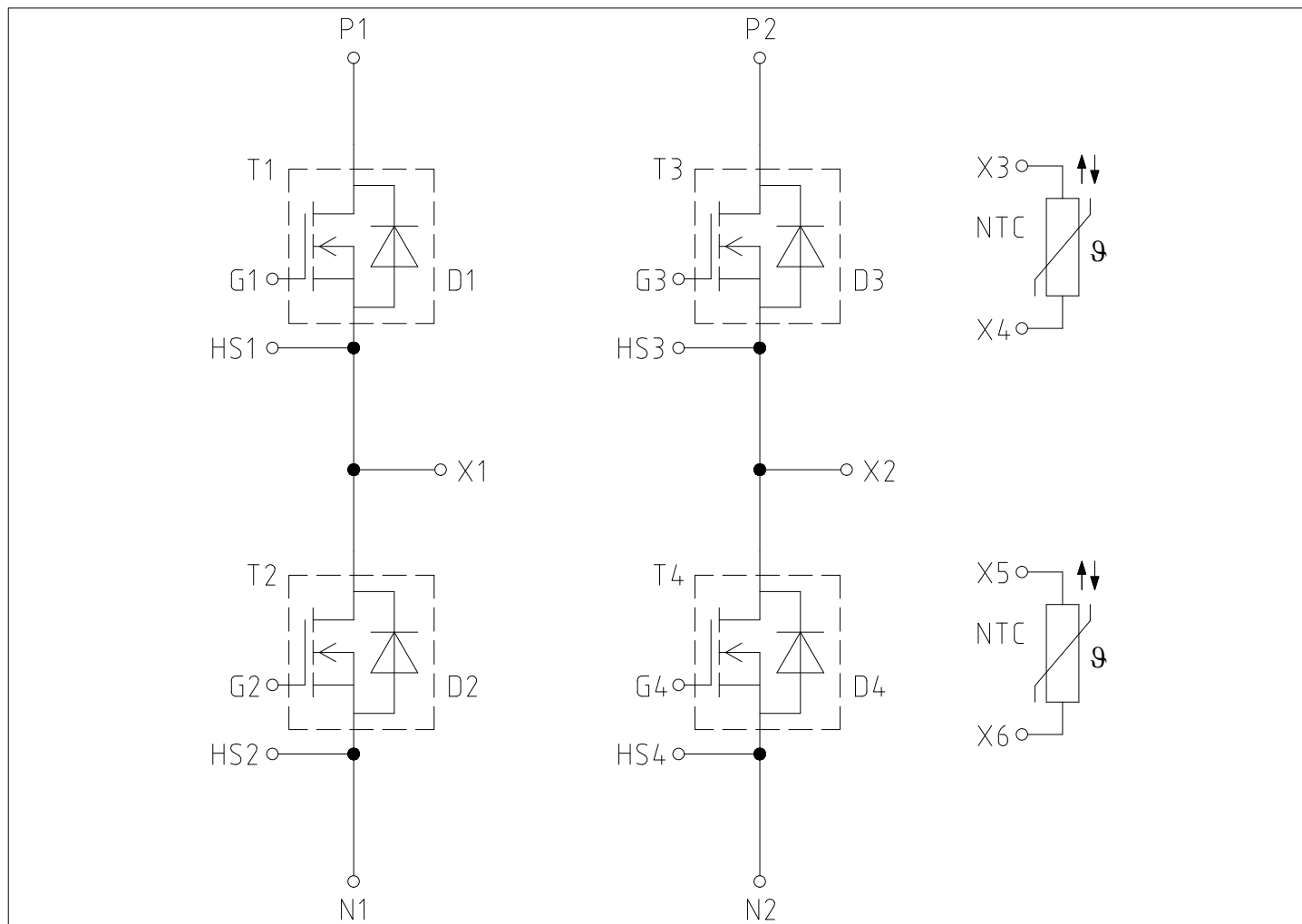
5 Characteristics diagrams

Temperature characteristic (typical), NTC-Thermistor

$R = f(T_{NTC})$



## 6 Circuit diagram



### Figure 1

7 Package outlines

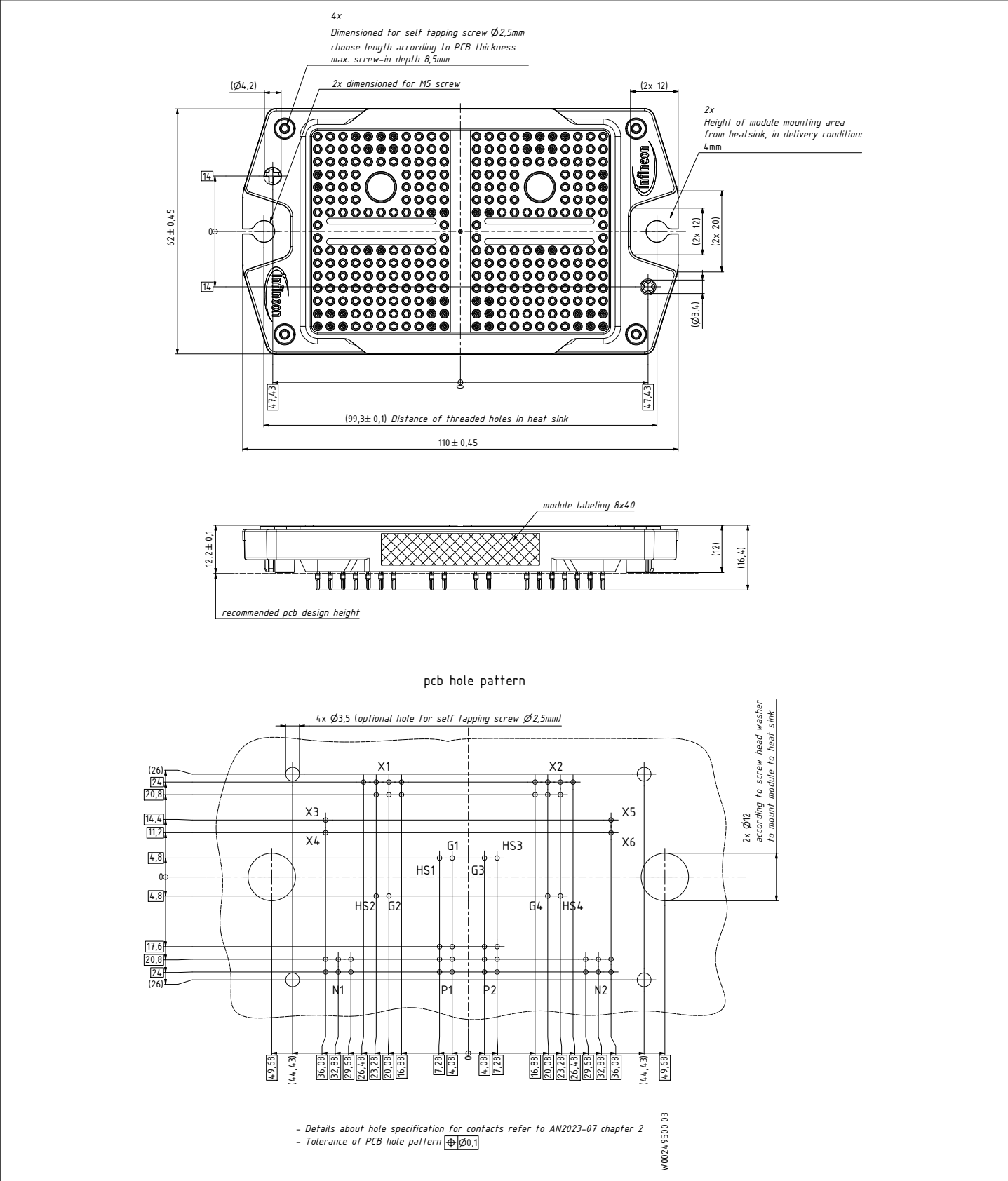


Figure 2

8 Module label code

| Module label code |                                                                                                                                                                                                                                           |         |                 |
|-------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---------|-----------------|
| Code format       | Data Matrix                                                                                                                                                                                                                               |         | Barcode Code128 |
| Encoding          | ASCII text                                                                                                                                                                                                                                |         | Code Set A      |
| Symbol size       | 16x16                                                                                                                                                                                                                                     |         | 23 digits       |
| Standard          | IEC24720 and IEC16022                                                                                                                                                                                                                     |         | IEC8859-1       |
| Code content      | Content                                                                                                                                                                                                                                   | Digit   | Example         |
|                   | Module serial number                                                                                                                                                                                                                      | 1 – 5   | 71549           |
|                   | Module material number                                                                                                                                                                                                                    | 6 - 11  | 142846          |
|                   | Production order number                                                                                                                                                                                                                   | 12 - 19 | 55054991        |
|                   | Date code (production year)                                                                                                                                                                                                               | 20 – 21 | 15              |
|                   | Date code (production week)                                                                                                                                                                                                               | 22 – 23 | 30              |
| Example           | <div><div>7154914284655054991153071549142846550549911530</div></div> |         |                 |

Figure 3



Revision history

Revision history

| Document revision | Date of release | Description of changes |
|-------------------|-----------------|------------------------|
| 0.10              | 2024-08-12      | Initial version        |
| 1.00              | 2024-11-11      | Final datasheet        |

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